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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re United States Patent Application of:) Docket No.:	2771-688 (7492)
Applicants:	KING, Mackenzie, et al.	Conf. No.:	7009
Application No.:	10/722,174	Art Unit:	1742
Date Filed:	November 25, 2003	Examiner:	SMITH, Nicholas A
Title:	ON-WAFER ELECTROCHEMICAL DEPOSITION PLATING METROLOGY PROCESS AND APPARATUS	Customer No.:	25559

FACSIMILE TRANSMISSION CERTIFICATE ATTN: Examiner Nicholas A. SMITH Fax No. (571) 273-8300

I hereby certify that this document is being filed in the United States Patent and Trademark Office, via facsimile transmission addressed to Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, and transmitted on the date specified below, to United States Patent and Trademark Office facsimile transmission number (571) 273-8300.

12 Number of Pages Steven J. Hultquist December 15, 2006 Date

RESPONSE TO SEPTEMBER 15, 2006 OFFICE ACTION IN U.S. PATENT **APPLICATION NO. 10/722,174**

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

This responds to the September 15, 2006 Office Action in the above-identified application.

Please amend the claims of the application as set out in the following Section I (Amendments to the Claims), beginning on the following page 3.

Remarks addressing the substance of the September 15, 2006 Office Action are set out in the Section II (Remarks), beginning on page 9 hereof.